IPC ASSOCIATION CONI	Material Comp © Copyright 2005. international and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					rials and N	ials and Mfc Information			
upplier Inf	formation														
Company name* Company uniqu				ique ID Unic			Unique ID Authority				Respon	Response Date*			
nsemi											2024-04	2024-04-19			
Contact Name	,	Title - Contact			I	Phone - Contact*				Email ·	Email - Contact*				
Product-Env-S	Stewards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
uthorized Re	epresentative*	Title - Representative			I	Phone - Representative*				Email ·	Email - Representative*				
Product-Env-Stewards Produc				roduct Enviro Compliance			NA				Produ	Product-Env-Stewards@onsemi.com			
Rec	Requester Item Number Mfr Ite		em Number Mfr Item Name				Effective Date Version Manufacturing		Manufacturing Site		Weight*	UOM	Unit Type		
		LV5235V-MPB-H 18ch LED driver				2024-04-19 PHM		PHM		350.0	mg	Each			
Ianufactur	ring Proccess Informa	ation						·					·	·	
Terminal Plating / Grid Array Material T			Ferminal Base Alloy J-STD-020 MSI		SL Rating	Peak Process Body Temperature		ure Max Time at Pea	k Tempera	ture Numb	er of Reflow Cyo	cles			
contains Bi			CU Alloy 3				260 C 30			seco	seconds 3				
omments															
TTENTION:	: MSL 3 Rated item requir	es Bake and D	ry Pack (afte	r electrical test)											
or more infor	rmation regarding materia	l composition	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct one bents it is form. Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	19.56	mg	Supplier	Silicon (Si)	7440-21-3		19.4876	mg
			Supplier	Polyimide	Proprietary Data		0.0724	mg
Die Attach	1.08		Supplier	Silver (Ag)	7440-22-4		0.918	mg
			Supplier	Epoxy resins	129915-35-1		0.1458	mg
			Supplier	Polybutadiene polymer	Proprietary Data		0.0162	mg
Lead Frame	123.0	mg	Supplier	Zinc (Zn)	7440-66-6		0.2337	mg
			Supplier	Iron (Fe)	7439-89-6		3.1857	mg
			Supplier	Copper (Cu)	7440-50-8		119.4084	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1722	mg
Mold Compound-Black	201.07			Epoxy Phenol Resin	proprietary data		24.1284	mg
			Supplier	Carbon Black (C)	1333-86-4		0.8043	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		170.1052	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		6.0321	mg
Plating	3.85	mg	В	Bismuth (Bi)	7440-69-9		0.0231	mg
			Supplier	Tin (Sn)	7440-31-5		3.8269	mg
Wire Bond - Au	1.44	mg	Supplier	Gold (Au)	7440-57-5		1.44	mg